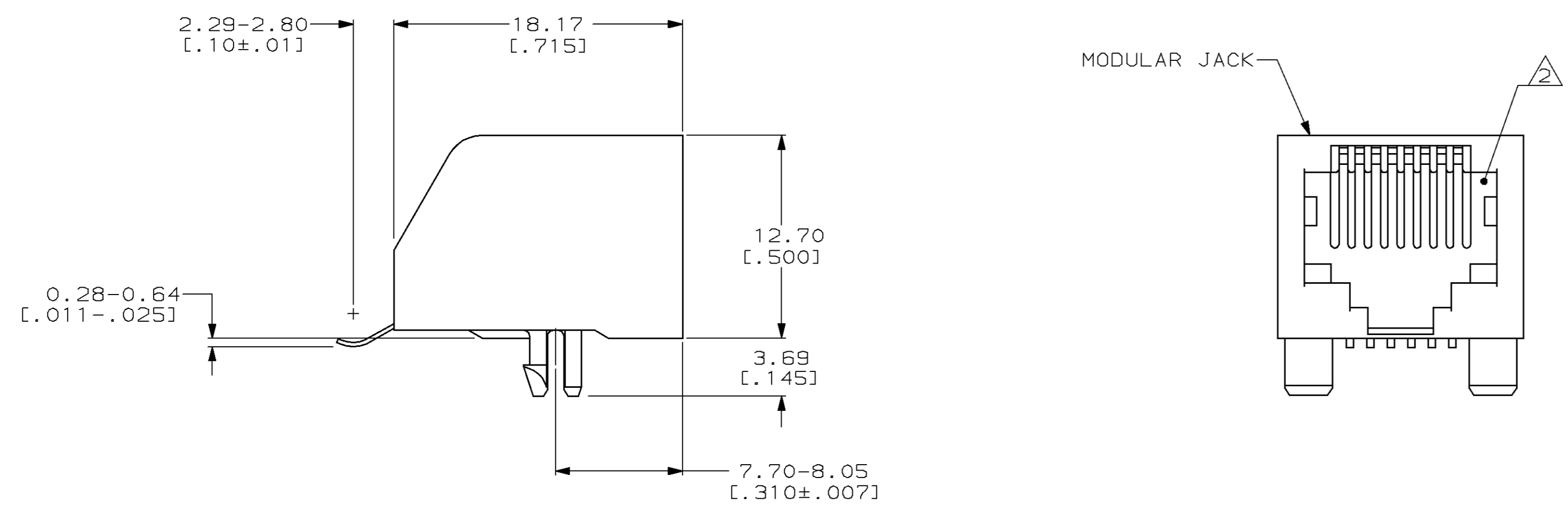
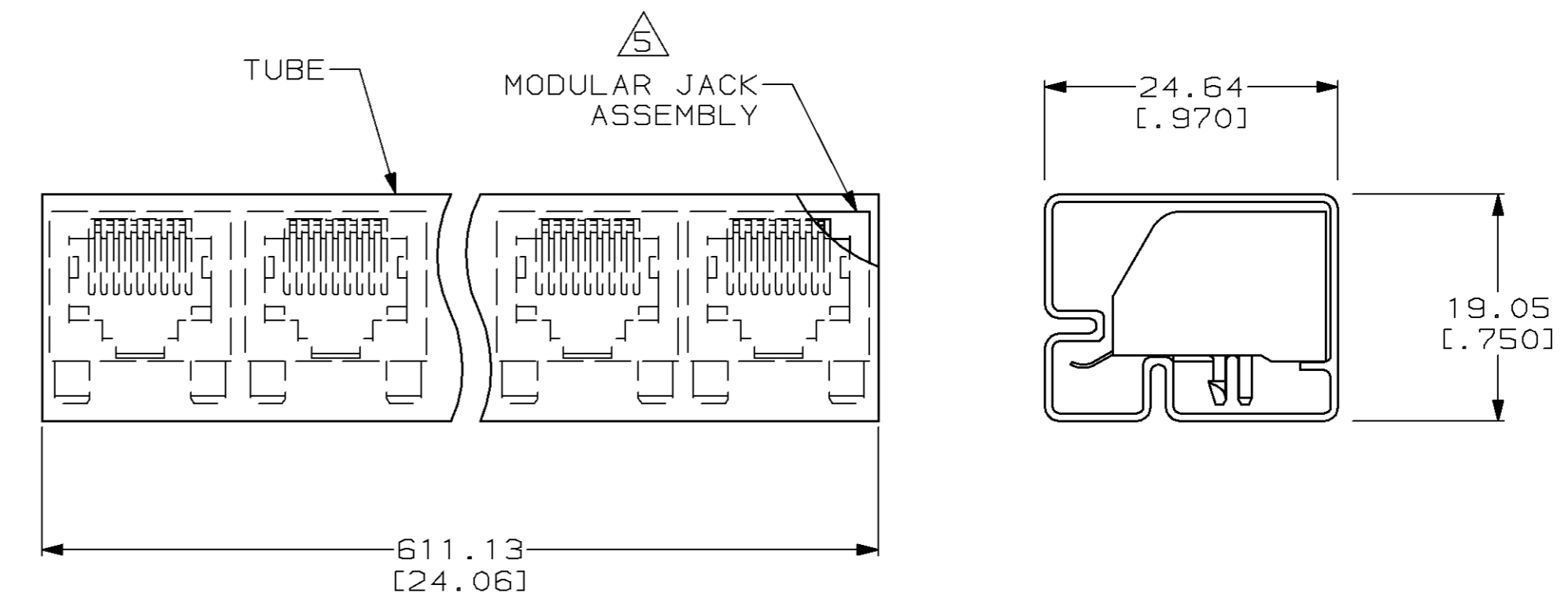
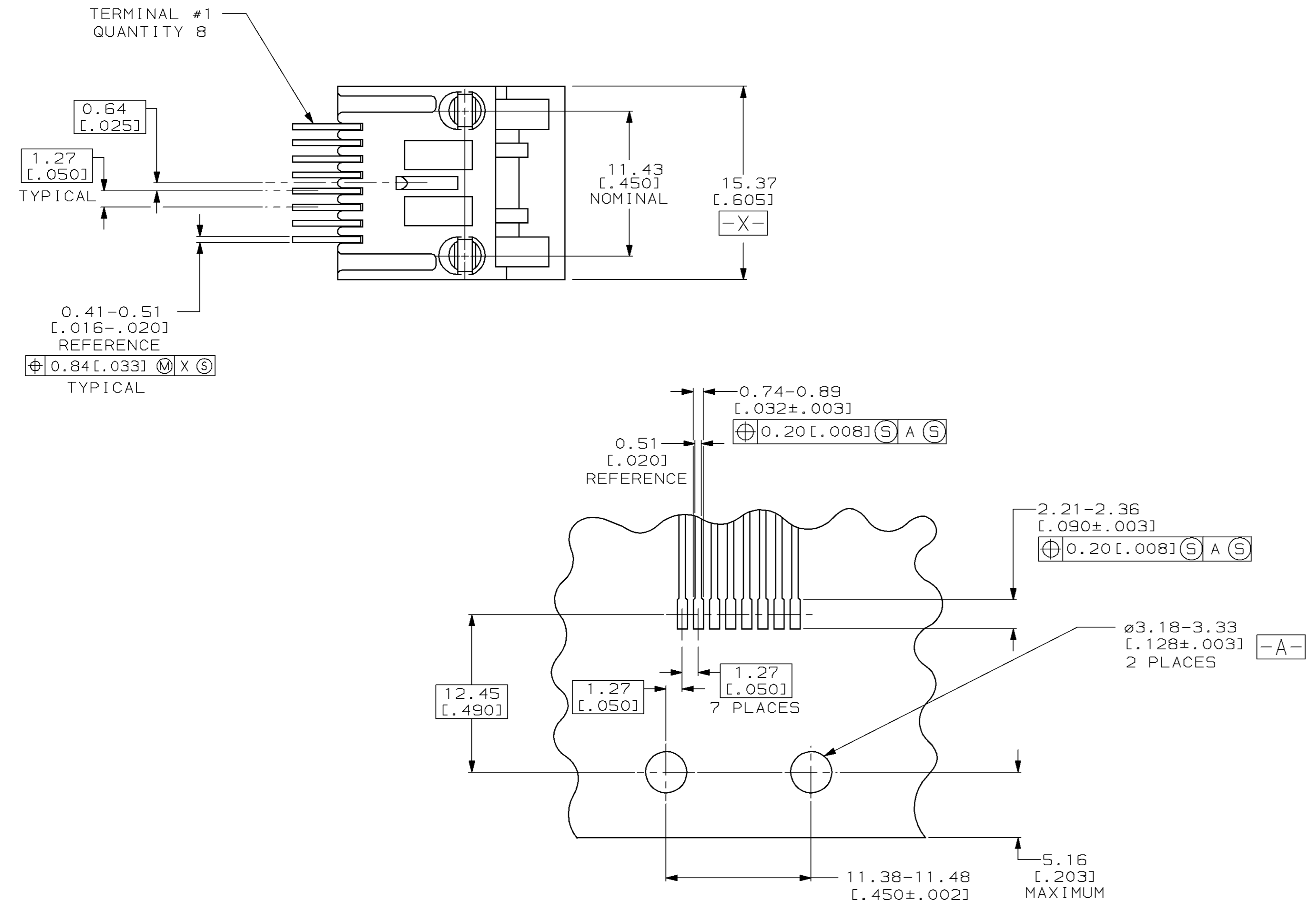


LOC		DIST		P		F		ZONE		LTR		REVISIONS			
AA	22											DESCRIPTION	DATE	APPD	
												P	REV; EC 0502-0711-97	230CT97	05



- 1. MATERIAL: HOUSING - HTN MOLDING COMPOUND, 94 V0, BLACK.
 TERMINAL - 0.36 [.014] THICK PHOS-BRONZE PLATE WITH 1.27µm [.000050] MINIMUM THICK HARD GOLD IN LOCALIZED GOLD PLATE AREA AND 3.81µm [.000150] MINIMUM THICK TIN-LEAD IN SOLDER AREA OVER 1.27µm [.000050] MINIMUM THICK NICKEL UNDERPLATE.
- 2. CAVITY CONFORMS TO FCC RULES AND REGULATIONS, PART 68, SUBPART F.
- 3. ALL DIMENSIONS SHOWN ARE MAXIMUM UNLESS OTHERWISE SPECIFIED AND ARE PRIOR TO SURFACE MOUNT PROCESSING.
- 4. SNAP-IN RETENTION FEATURE ACCOMMODATES 1.45-1.70 [.062±.005] THICK PRINTED CIRCUIT BOARD.
- 5. ASSEMBLIES ARE PACKAGED 36 IN A TUBE.
- 6. ASSEMBLIES ARE BULK PACKAGED.



DETAIL A
SCALE 2:1

RECOMMENDED PRINTED CIRCUIT BOARD LAYOUT

THIS DRAWING IS A CONTROLLED DOCUMENT FOR AMP INCORPORATED. IT IS SUBJECT TO CHANGE AND THE CONTROLLING ENGINEERING ORGANIZATION SHOULD BE CONTACTED FOR THE LATEST REVISION.

DO NOT SCALE PRINT. UNLESS SPECIFIED DIMENSIONS IN mm [INCHES] TOLERANCES ON:		DR 9-28-95 D. STRAUSSER		8		555764-3	
2 PLC DEC ± -		CHK 10-17-95 N. JONES		8		555764-1	
3 PLC DEC ± -		APPD 10-23-95 J. TONEY		PACKAGED		NUMBER OF TERMINALS	
ANGLES ± -		APPD 10-24-95 H. MCGRATHS		8		PART NO	
MATERIAL		PRODUCT SPEC 108-1163		AMP Incorporated Harrisburg, PA 17105-3608			
FINISH		APPLICATION SPEC 114-6040					
SCALE 4:1		CAGE CODE 00779		NAME		MODULAR JACK ASSEMBLY, 8 POSITION, LOW PROFILE, RIGHT ANGLE, SURFACE MOUNT	
DRAWING NO C=555764		SHEET 1 OF 1					